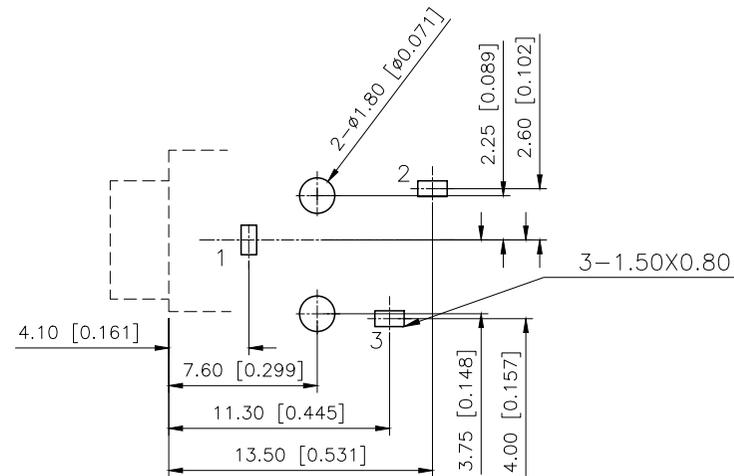
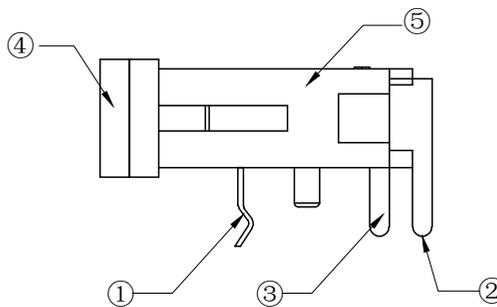
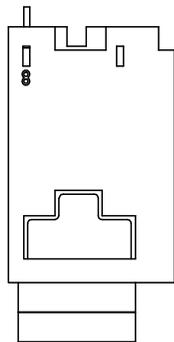
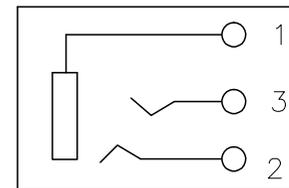


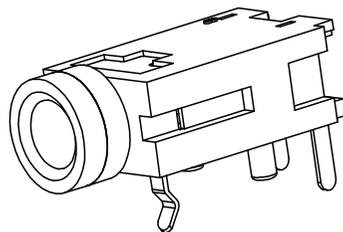
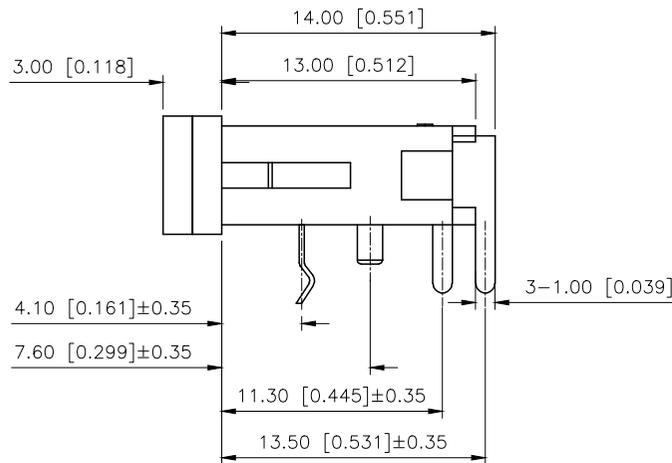
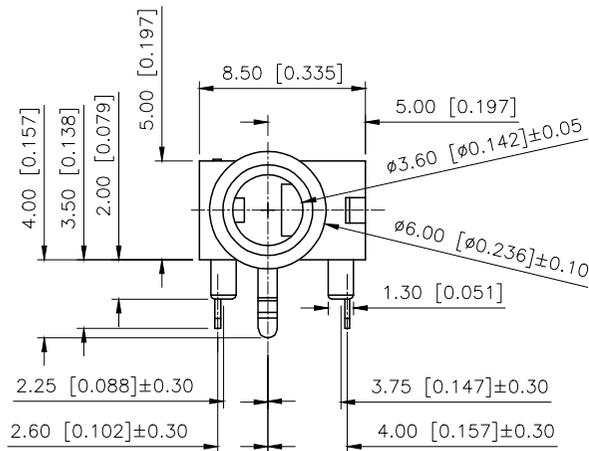
REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		参照实物修正图纸, 图面升级整理图面	2024.9.12	阿树



PCB LAYOUT TOP VIEW



CIRCUIT DIAGRAM



SPECIFICATIONS:

- Rating : DC 30V 0.5A;
- Contact resistance: $\leq 30m\Omega$
- Insulation resistance: $\geq 100M\Omega$ (DC250V)
- Withstand voltage: 500VAC :
- Insertion and extraction force: 3-25N
- life test: 5,000 cycles.

5	Housing	1	PA	Black
4	Copper sleeve	1	Brass	
3	3# Terminal	1	Phosphor Bronze	T=0.25
2	2# Terminal	1	Phosphor Bronze	T=0.30
1	1# Terminal	1	Brass	T=0.25
NO	PRART NAME	QTY	MATERIAL	SPECIFICATIONS

AuGLAR	$\pm 5^\circ$
X.	± 0.40
X.x	± 0.30
X.xx	± 0.20
X.xxx	± 0.15
UNSPECIFIED TOLERAuCES	



DESIGN
CHECKED
APPROVED

阿树

VIEW:

UNIT: mm/in

SIZE: A4

MODEL TYPE:
3.5 PHONE JACK
PART NO.:
PJ-319
DWG NO.:

XKB INDUSTRIAL PRECISION CO., LIMITED

SCALE	PAGE	REVISION
N/A	1/1	A1